Qualcom

RF360 Europe GmbH

Data sheet

SAW duplexer Automotive telematics LTE band 7

Part number:	B4438
Ordering code:	B39272B4438P810
Date:	May 19, 2020

2.0

Version:

DCN: 80-PA243-471 Rev. A

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries").

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

 $\ensuremath{\mathbb{C}}$ 2020 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.



These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm is a trademark of Qualcomm Incorporated, registered in the United States and other countries. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.

Table of contents

1 Application	4
2 <u>Features</u>	4
4 Pin configuration	5
5 <u>Matching circuit</u>	6
6 Characteristics	
7 Maximum ratings	
8 Transmission coefficients	
9 Reflection coefficients	14
10 Packing material	15
11 Marking	
12 Soldering profile.	
13 Annotations	
14 Cautions and warnings.	21
15 Important notes	22

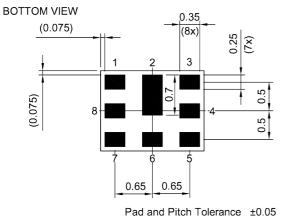
Qualconversion RF360 Europe GmbH

- 1 Application
- LTE band 7 uplink: 2535 MHz (pass band 70 MHz)
- LTE band 7 downlink: 2655 MHz (pass band 70 MHz)
- Low loss SÄW duplexer for band 7 systems
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 70 MHz
- High isolation between Tx and Rx
- 2 Features
- Package size 1.8±0.1 mm × 1.4±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 4 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Overmold demonstrated with RF360 specific mold process
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: -40 °C to +85 °C)



Figure 1: Picture of component with example of product marking.

3 Package

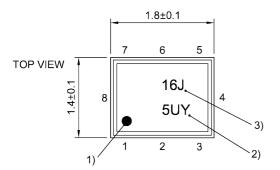


4 **Pin configuration**

- 1 RX
- **3** ТΧ
- ANT **6**
- **■** 2, 4, 5, 7, Ground 8

SIDE VIEW





1) Marking for pad number 1

2) Example of encoded lot number

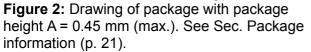
0.4

3) Example of encoded filter type number

Land pattern THRU VIEW

(7x)(8x 0.3 5 7 6 0.5 8 0.5 Ċ 0.65 0.65

Landing pad tolerance -0.02





5 Matching circuit

■ $L_{p6} = 3.6 \text{ nH}$

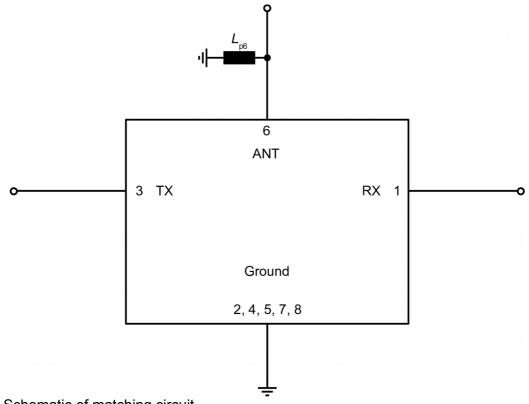


Figure 3: Schematic of matching circuit.

6 Characteristics

6.1 TX – ANT

Temperature range for specification	T _{SPEC}	= −40 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω
ANT terminating impedance	Z	= 50 Ω // 3.6 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics TX – ANT				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for T _{SPEC}	
Center frequency			f _c	—	2535	—	MHz
Maximum insertion attenuation			α_{max}				
	2500 2570	MHz		_	1.9	3.2	dB
Amplitude ripple (p-p)			Δα				
	2500 2570	MHz		_	1.1	2.1	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	2500 2570	MHz		—	1.9	2.2	
@ ANT port	2500 2570	MHz		—	1.8	2.0	
Average attenuation			$\alpha_{avg}^{2)}$				
Ch12	2457 2477	MHz		27	48	—	dB
Ch13	2462 2482	MHz		12	29	—	dB
Minimum attenuation			$\alpha_{_{min}}$				
	50 500	MHz		50	57	—	dB
	500 1710	MHz		33	37	—	dB
	1710 2400	MHz		30	35	—	dB
	2400 2472	MHz		38	41	—	dB
	2472 2481	MHz		6	21	—	dB
	2620 2690	MHz		46	53	—	dB
	2690 5300	MHz		35	39	_	dB
	5300 6000	MHz		40	54	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Average values within each WiFi channel width of 20.0 MHz.

6.2 ANT – RX

Temperature range for specification	T _{SPEC}	= −40 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω
ANT terminating impedance	Z	= 50 Ω // 3.6 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics ANT – RX				min. for $T_{\rm SPEC}$	typ. @ +25 °C	max. for T _{SPEC}	
Center frequency			f _c	—	2655	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	2620 2690	MHz		_	2.3	3.2	dB
Amplitude ripple (p-p)			Δα				
	2620 2690	MHz		—	1.1	1.9	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	2620 2690	MHz		—	1.8	2.1	
@ RX port	2620 2690	MHz		—	2.0	2.3	
Minimum attenuation			$\alpha_{_{min}}$				
	50 500	MHz		50	64	—	dB
	500 1710	MHz		40	45	_	dB
	1710 2400	MHz		40	44	—	dB
	2400 2500	MHz		40	50	—	dB
	2500 2570	MHz		48	52	—	dB
	2715 2750	MHz		3	20	—	dB
	2750 6000	MHz		40	46	_	dB

¹⁾ See Sec. Matching circuit (p. 6).

TX – RX 6.3

Temperature range for specification	T _{SPEC}	= −40 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω
ANT terminating impedance	Z	= 50 Ω // 3.6 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics TX – RX				min. for $T_{\rm SPEC}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Minimum isolation			α _{min}				
	1574 1577	MHz		55	65	—	dB
	2500 2535	MHz		_	53 ²⁾	—	dB
	2500 2570	MHz		51	53	—	dB
	2535 2570	MHz		_	54 ²⁾	—	dB
	2570 2620	MHz		37	41	—	dB
	2620 2690	MHz		52	54	—	dB
	5000 5140	MHz		40	45	—	dB

1)

See Sec. Matching circuit (p. 6). Valid for temperature T = +25 °C...+60 °C. 2)

7 **Maximum ratings**

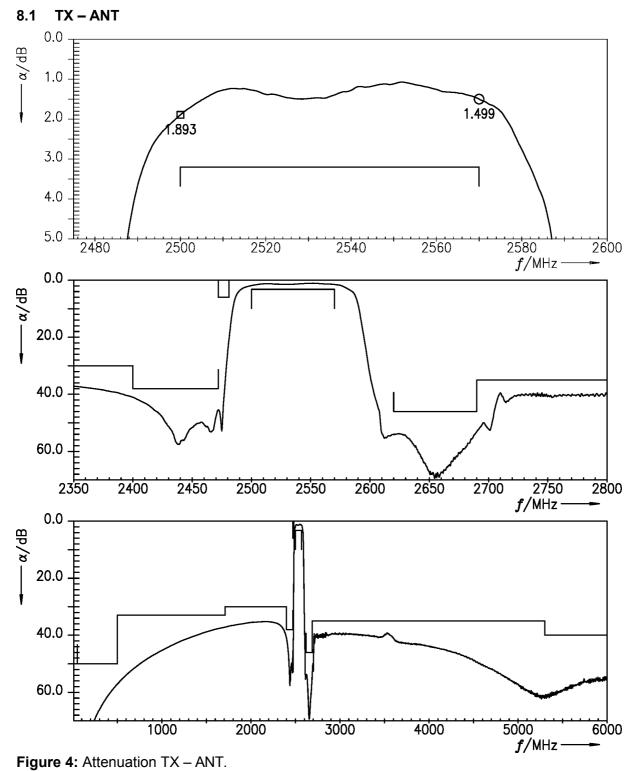
Operable temperature	<i>T</i> _{OP} = -40 °C +85 °C	
Storage temperature	$T_{\rm STG}^{1)} = -40 ^{\circ}{\rm C} \dots +85 ^{\circ}{\rm C}$	
DC voltage	$ V_{\rm DC} ^{2)} = 0 \rm V (max.)$	
Input power @ TX port: 2500 2570 MHz	P _™ = 28 dBm	Continuous wave for 5000 h @ 50 °C.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C. In case of applied DC voltage blocking capacitors are mandatory. 1)

2)

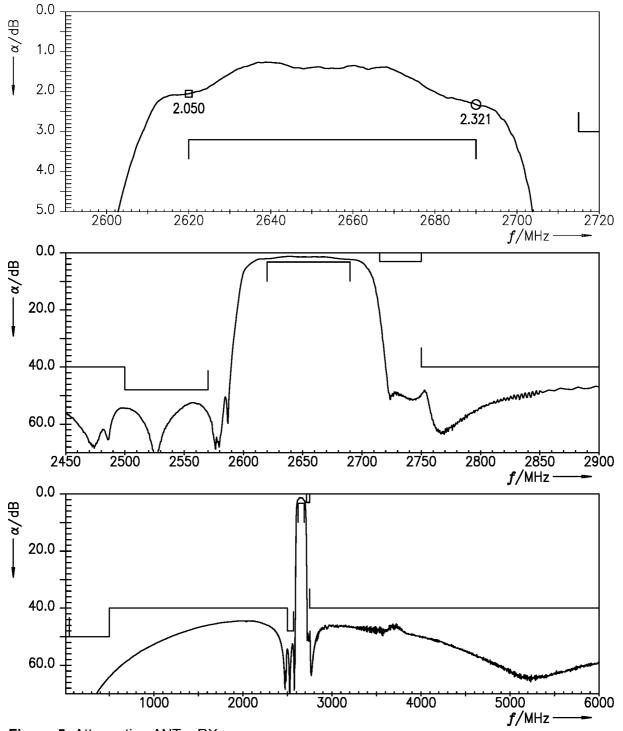


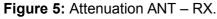
8 Transmission coefficients



Qualconn RF360 Europe GmbH

8.2 ANT – RX

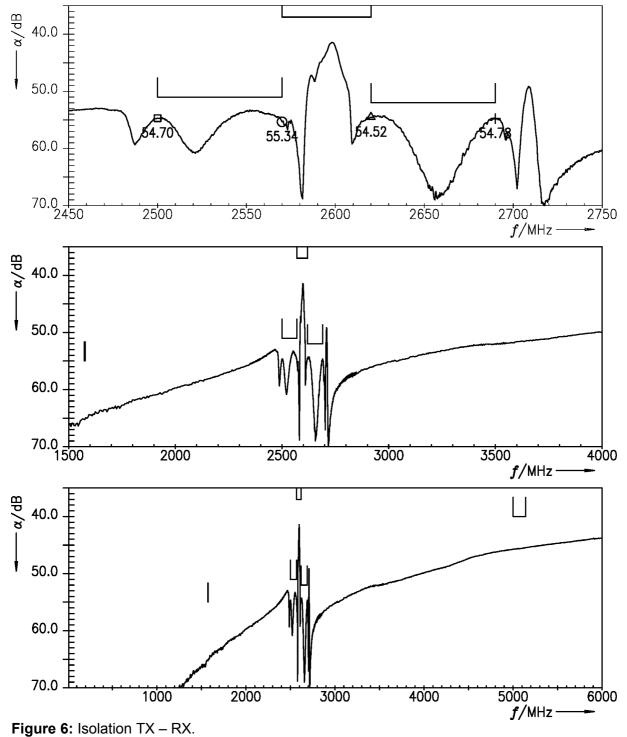




Please read **Cautions and warnings** and **Important notes** at the end of this document.

Qualconversion RF360 Europe GmbH

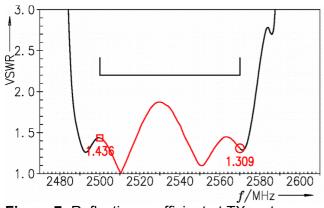
8.3 TX – RX





□ = 2500.0 O = 2570.0

9 Reflection coefficients





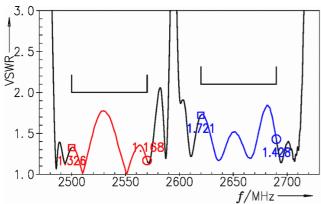
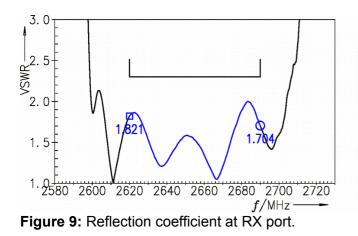
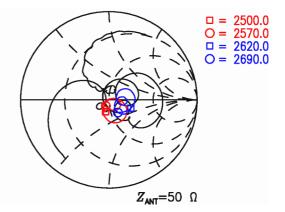
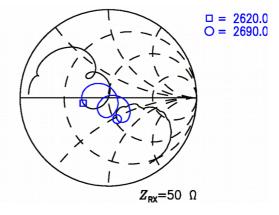


Figure 8: Reflection coefficient at ANT port.





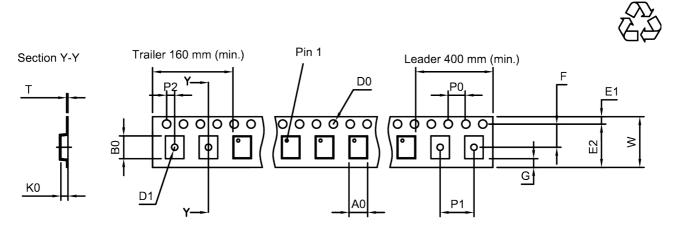
Z_{TX}=50 Ω





10 Packing material

10.1 Tape



User direction of unreeling

Figure 10: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 A0
 1.6±0.05 mm

 B0
 2.0±0.05 mm

 D0
 1.5±0.1/-0 mm

 D1
 0.8±0.1/-0 mm

 E1
 1.75±0.1 mm

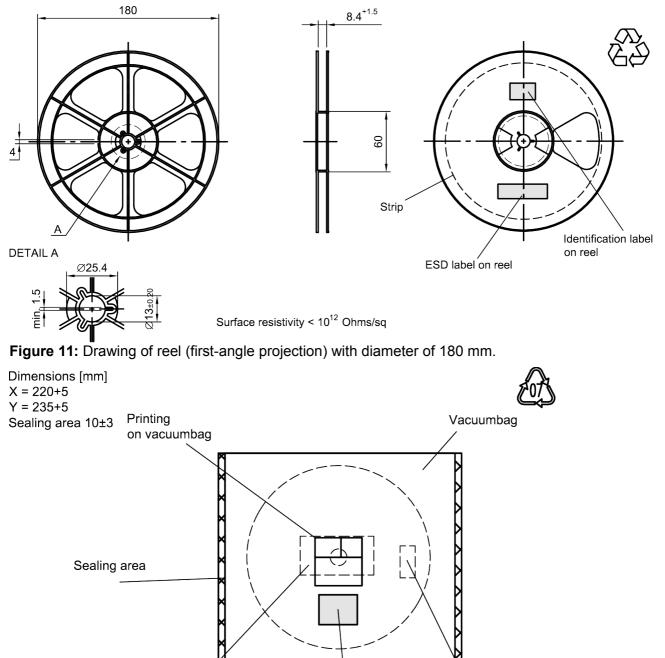
Table 1: Tape dimensions.

6.25 mm (min.)
3.5±0.05 mm
0.75 mm (min.)
0.64±0.05 mm
4.0±0.1 mm

P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm



10.2 Reel with diameter of 180 mm



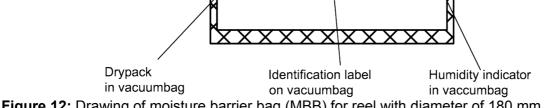
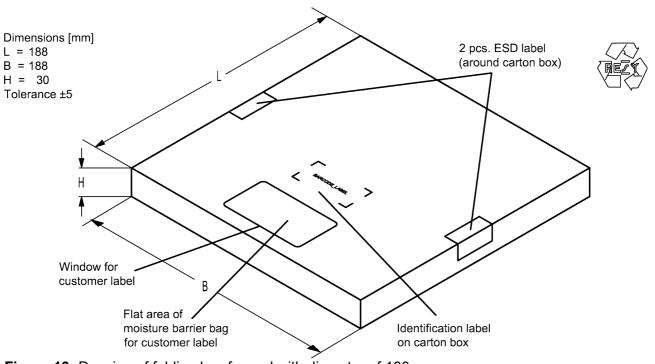
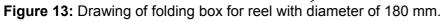


Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

Qualconn RF360 Europe GmbH





lalcom **RF360 Europe GmbH**

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit	marking.	e.g., B3xxxxB <u>1234</u> xxxx,
Example of decoding type number marking on 16J 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 The BASE32 code for product type B4438 is 4AP.	device => =	in decimal code. 1234 1234

■ Lot number:

The last 5 digits of the lot number, 12345, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device 5UY

decoding lot number marking on device		in decimal code.
5UY	=>	12345
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=	12345

Adopted BASE32 code for type number				
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	K	
4	4	20	М	
5	5	21	N	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	A	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	Х
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	K	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s	
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s	
<i>T</i> > 220 °C	30 s to 70 s	
<i>T</i> > 230 °C	min. 10 s	
<i>T</i> > 245 °C	max. 20 s	
<i>T</i> ≥ 255 °C	-	
peak temperature T_{peak}	250 °C +0/-5 °C	
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s	
cooling rate	≤ 3 K/s	
soldering temperature T	measured at solder pads	

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

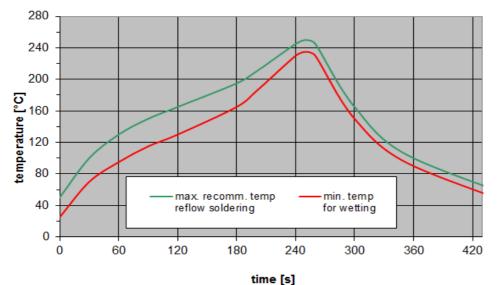


Figure 14: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (<u>https://rffe.qualcomm.com</u>). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.

The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

单击下面可查看定价,库存,交付和生命周期等信息

>>Qualcomm-RF360